

## UF630

Power MOSFET

200V, 9A N-CHANNEL  
POWER MOSFET

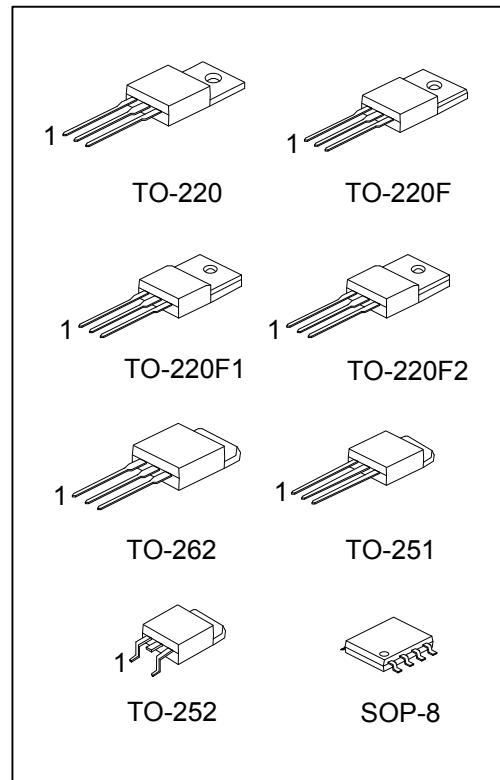
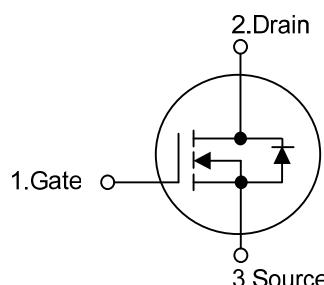
## ■ DESCRIPTION

The N-Channel enhancement mode silicon gate power MOSFET is designed for high voltage, high speed power switching applications such as switching regulators, switching converters, solenoid, motor drivers, relay drivers.

## ■ FEATURES

- \*  $R_{DS(ON)} < 0.4\Omega$  @  $V_{GS} = 10V$ ,  $I_D = 5A$
- \* Ultra Low Gate Charge ( typical 19 nC )
- \* Low Reverse Transfer Capacitance (  $C_{RSS}$  = typical 80 pF )
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability

## ■ SYMBOL



## ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment								Packing
Lead Free	Halogen Free		1	2	3	4	5	6	7	8	
UF630L-TA3-T	UF630G-TA3-T	TO-220	G	D	S	-	-	-	-	-	Tube
UF630L-TF1-T	UF630G-TF1-T	TO-220F1	G	D	S	-	-	-	-	-	Tube
UF630L-TF2-T	UF630G-TF2-T	TO-220F2	G	D	S	-	-	-	-	-	Tube
UF630L-TF3-T	UF630G-TF3-T	TO-220F	G	D	S	-	-	-	-	-	Tube
UF630L-TM3-T	UF630G-TM3-T	TO-251	G	D	S	-	-	-	-	-	Tube
UF630L-TN3-R	UF630G-TN3-R	TO-252	G	D	S	-	-	-	-	-	Tape Reel
UF630L-T2Q-T	UF630G-T2Q-T	TO-262	G	D	S	-	-	-	-	-	Tube
-	UF630G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

 UF630L-TA3-T	(1)T: Tube, R: Tape Reel
	(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2,
	TF3: TO-220F, TM3: TO-251, TN3: TO-252, T2Q: TO-262, S08: SOP-8
(3) L: Lead Free, G: Halogen Free and Lead Free	

**■ MARKING**

TO-220 / TO-220F / TO-220F1 TO-220F2 / TO-252 / TO-262	SOP-8
<p>1 Lot Code Data Code G: Halogen Free</p>	<p>8 7 6 5 Date Code UTC UF630G 1 2 3 4 Lot Code</p>

■ ABSOLUTE MAXIMUM RATINGS ( $T_c = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	200	V
Drain-Gate Voltage ( $R_{GS} = 20\text{k}\Omega$ , $T_J = 25^\circ\text{C} \sim 125^\circ\text{C}$ )	$V_{DGR}$	200	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	9	A
Pulsed Drain Current (Note 2)	$I_{DM}$	36	A
Single Pulse Avalanche Energy (Note 3)	$E_{AS}$	150	mJ
Power Dissipation	TO-220/TO-262	73	W
	TO-220F1/ TO-220F	38	
	TO-220F2	42	
	TO-251/ TO-252	46	
	SOP-8	5	
Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by  $T_J$ .

3.  $L = 4\text{mH}$ ,  $I_{AS} = 8.3\text{A}$ ,  $V_{DD} = 20\text{V}$ ,  $R_G = 25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-262	62.5	$^\circ\text{C/W}$
	TO-220F1/ TO-220F		
	TO-220F2		
Junction to Case	TO-251/ TO-252	100.3	$^\circ\text{C/W}$
	SOP-8	83	
	TO-220/TO-262	1.71	
	TO-220F1/ TO-220F	3.31	
	TO-220F2	2.98	
	TO-251/ TO-252	2.7	$^\circ\text{C/W}$
	SOP-8	24	

■ ELECTRICAL SPECIFICATIONS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$	200			V
On-State Drain Current (Note 1)	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} > I_{\text{D}(\text{ON})} \times R_{\text{DS}(\text{ON})\text{MAX}}, V_{\text{GS}} = 10\text{V}$	9			A
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}} = \text{Rated } \text{BV}_{\text{DSS}}, V_{\text{GS}} = 0\text{V}$		10		$\mu\text{A}$
Gate-Source Leakage Current	Forward	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
	Reverse	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$	2		4	V
Static Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 5\text{A}$		0.25	0.4	$\Omega$
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0\text{MHz}$		600		pF
Output Capacitance	$C_{\text{OSS}}$			250		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			80		pF
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DD}} = 90\text{V}, I_{\text{D}} \approx 9\text{A}, R_{\text{GS}} = 9.1\Omega, V_{\text{GS}} = 10\text{V}, R_{\text{L}} = 9.6\Omega$ (Note 1, 2)			30	ns
Turn-On Rise Time	$t_{\text{R}}$				50	ns
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$				50	ns
Turn-Off Fall Time	$t_{\text{F}}$				40	ns
Total Gate Charge	$Q_{\text{G}}$	$V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 9\text{A}, V_{\text{DS}} = 0.8 \times \text{Rated } \text{BV}_{\text{DSS}}$ $I_{\text{G}(\text{REF})} = 1.5\text{mA}$		19	30	nC
Gate-Source Charge	$Q_{\text{GS}}$			10		nC
Gate-Drain Charge	$Q_{\text{GD}}$			9		$\mu\text{C}$
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Drain-Source Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 9.0\text{A}$			2	V
Maximum Continuous Drain-Source Diode Forward Current	$I_{\text{S}}$				9	A
Maximum Pulsed Drain-Source Diode Forward Current	$I_{\text{SM}}$				36	A
Reverse Recovery Time	$t_{\text{rr}}$	$I_{\text{S}} = 9.0\text{A}, dI_{\text{S}}/dt = 100\text{A}/\mu\text{s}$ (Note 1)		450		ns
Reverse Recovery Charge	$Q_{\text{RR}}$			3		$\mu\text{C}$

Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

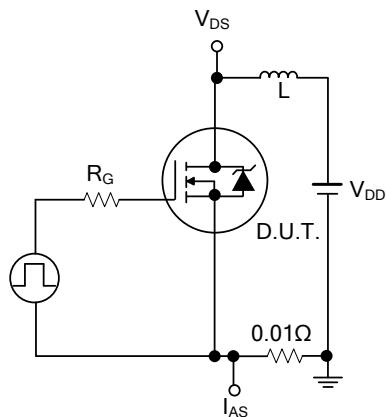


Fig.1 Unclamped Energy Test Circuit

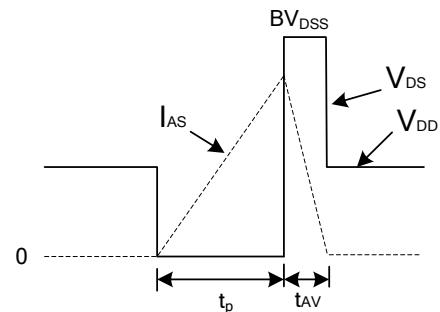


Fig.2 Unclamped Energy Waveforms

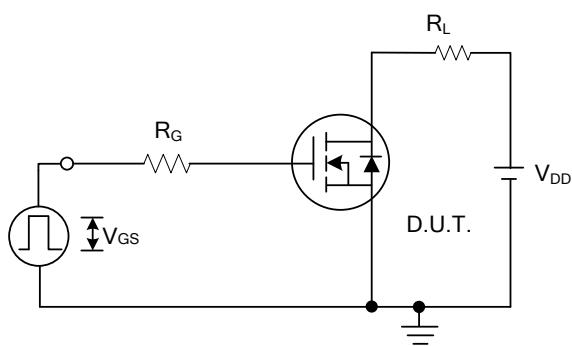


Fig.3 Switching Time Test Circuit

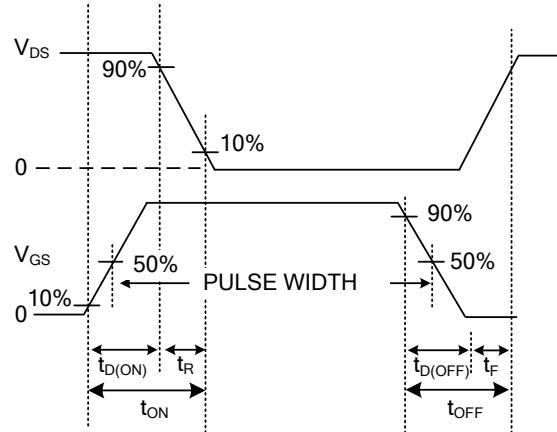


Fig.4 Resistive Switching Waveforms

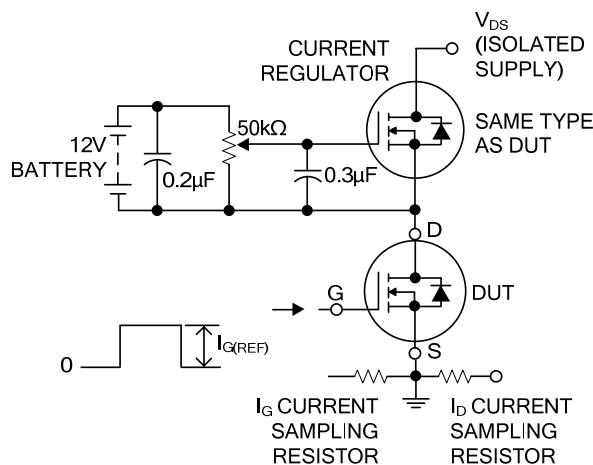


Fig.5 Gate Charge Test Circuit

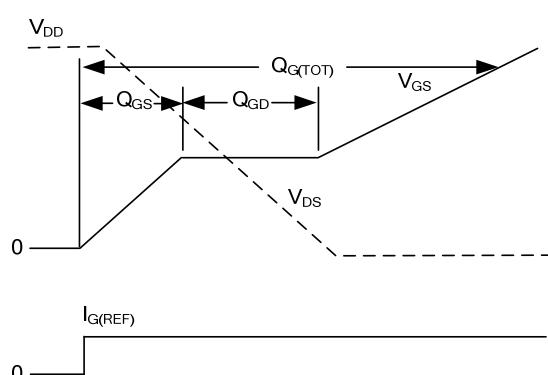
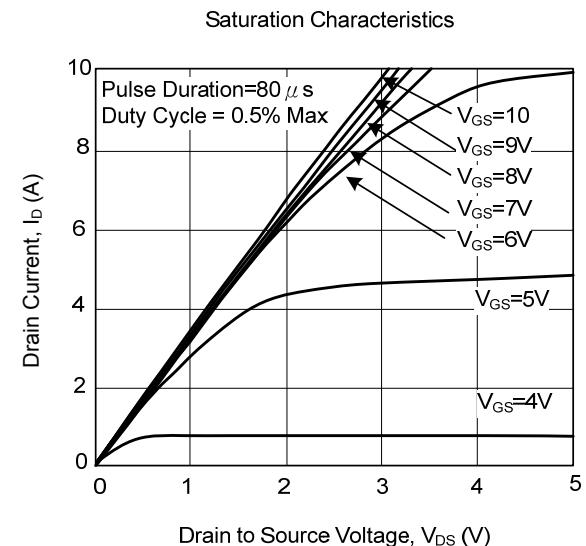
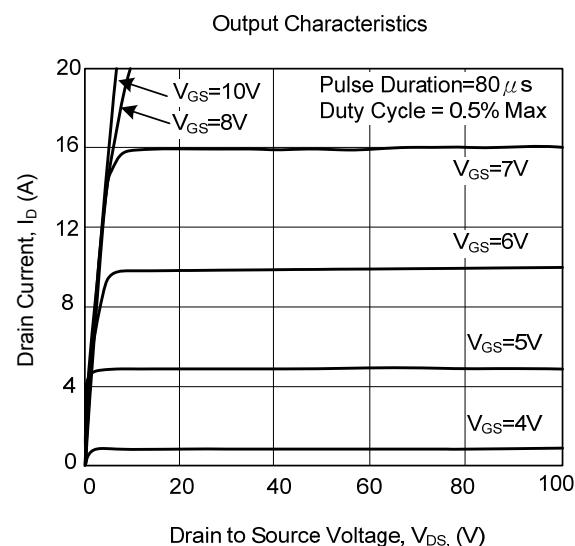
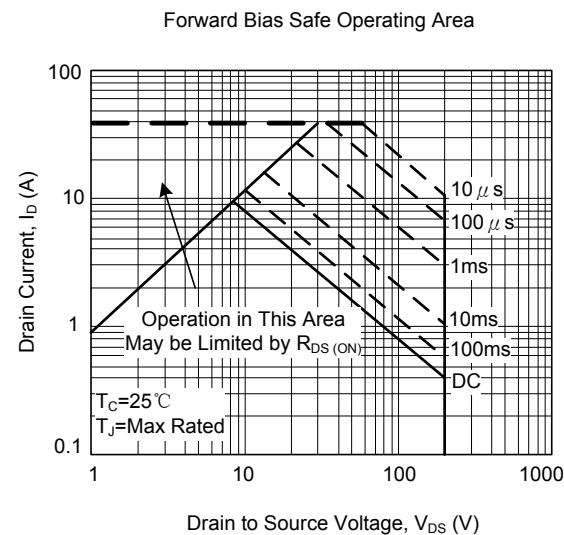
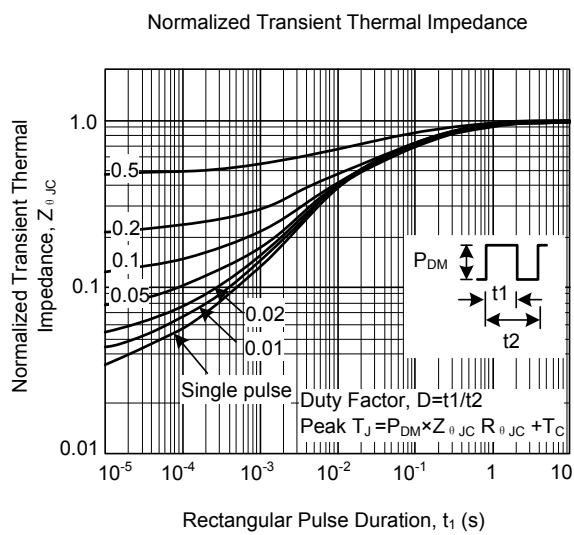
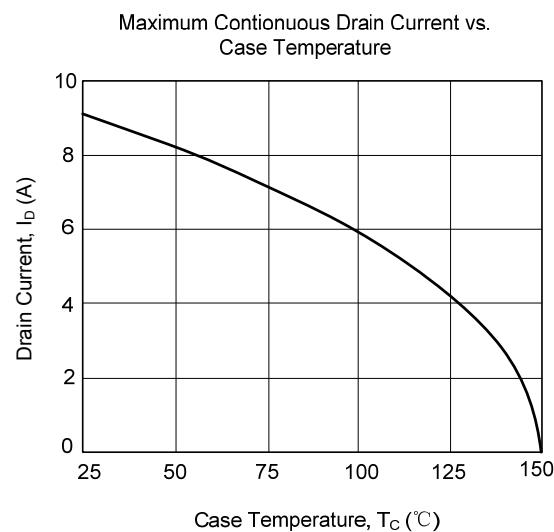
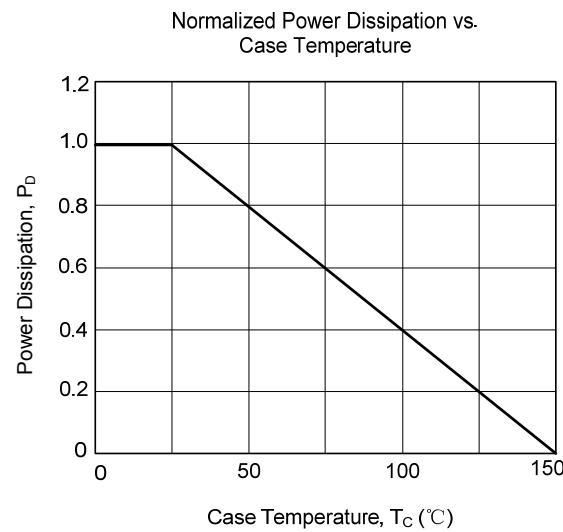
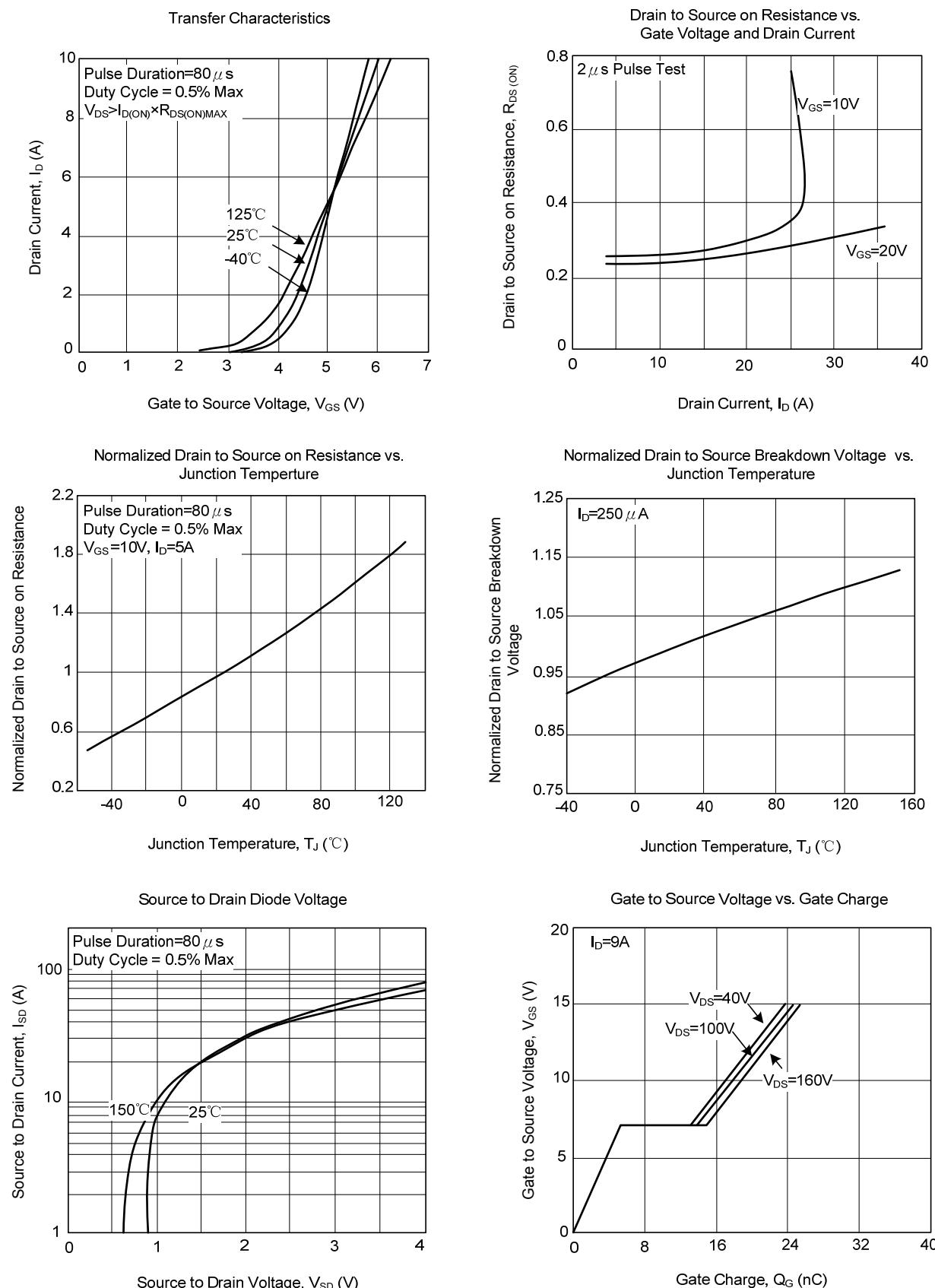


Fig.6 Gate Charge Waveforms

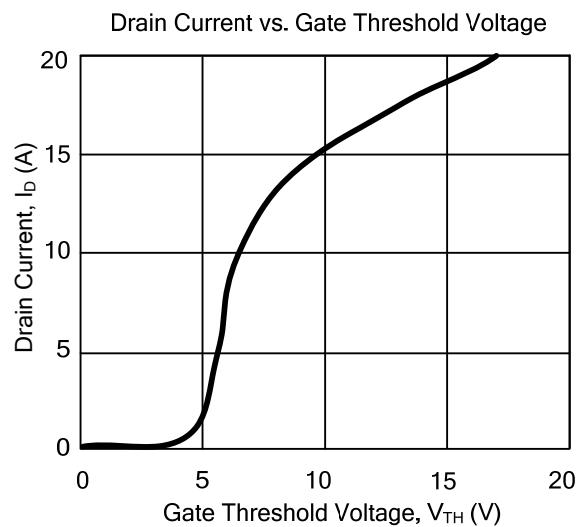
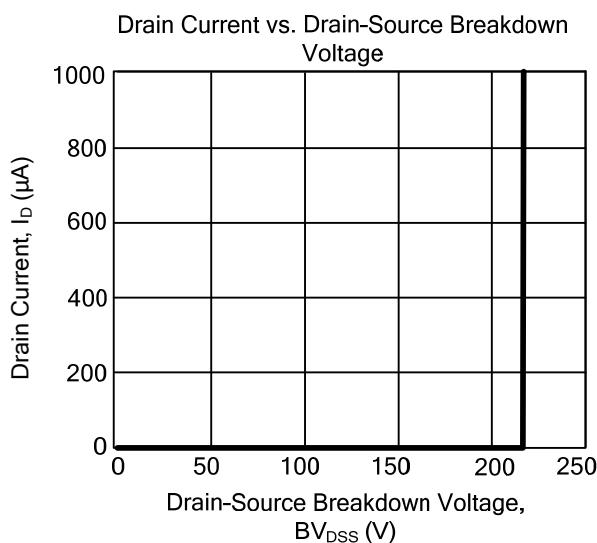
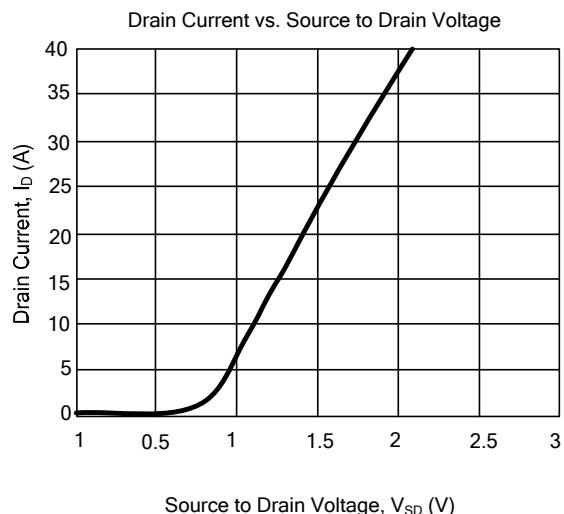
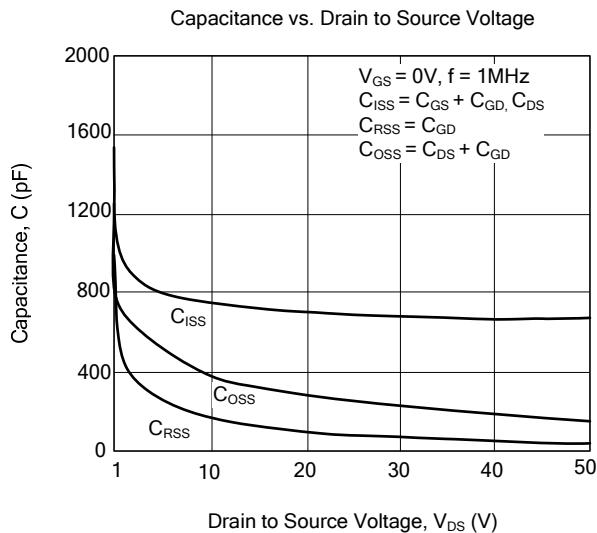
■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



## ■ TYPICAL CHARACTERISTICS (Cont.)



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